





# **KW1148C**1608 (h=0.35 mm) Type White LED

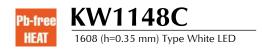
#### **Features**

Package	1608 (h=0.35 mm) Type, Pale yellow resin
Product features	<ul> <li>Outer Dimension 1.6 x 0.8 x 0.35mm(L x W x H)</li> <li>Temperature range     Storage Temperature : -40°C~100°C     Operating Temperature : -40°C~ 85°C</li> <li>Lead-free soldering compatible</li> <li>RoHS compliant</li> </ul>
Chromaticity coordinates	$x = 0.27TYP., y = 0.26TYP.$ (Condition: $I_F=1mA$ )
Half Intensity Angle	$\theta$ x = 132 deg., $\theta$ y =150 deg.
Die materials	InGaN
Rank grouping parameter	Sorted by luminous intensity and chromaticity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi$ 180mm
ESD	1kV (HBM)

## **Recommended Applications**

Cellular Phone only





## Color and Luminous Intensity

(Ta=25℃)

Part No.	Material	Emitted Color			Lens Color	Lum	inous Inte	nsity
				MIN.	TYP.	I <sub>F</sub>		
KW1148C	InGaN	White	Pale Yellow	10	25	1		





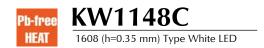
## Absolute Maximum Ratings

(Ta=25℃)

ltem	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	$P_d$	21	mW
Forward Current	I <sub>F</sub>	6	mA
Pulse Forward Current <sup>※1</sup>	I <sub>FRM</sub>	12	mA
Derating	$\Delta I_{F}$	0.08	mA/°C
(Ta=25°C or higher)	⊿I <sub>FRM</sub>	0.16	mA/°C
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	-40~+85	ာ
Storage Temperature	$T_{stg}$	-40 <b>~</b> +100	ဗ

 $<sup>11 \</sup>text{ I}_{FRM}$  Measurement condition : Pulse Width  $11 \text{ I}_{rsm}$  Duty 1/20.





## **Electro-Optical Characteristics**

(Ta=25℃)

Hom		Symphol	Characteristics		11	
Item	Conditions	Symbol	Cnara	cteristics	Unit	
Famurand Valtage	I1 A	V	TYP.	2.8	v	
Forward Voltage	I <sub>F</sub> =1mA	V <sub>F</sub>	MAX.	3.0	V	
Reverse Current	V <sub>R</sub> =5V	I <sub>R</sub>	MAX.	100	μΑ	
III. If Indonesia, America		2 θ 1/2	TYP.	132(θ x)	deg.	
Half Intensity Angle	I <sub>F</sub> =1mA			150(θy)		
Chromaticity		x	TYP.	0.27	-	
Coordinates	I <sub>F</sub> =1mA	y	TYP.	0.26	-	





## Luminous Intensity Rank

(Ta=25℃)

Intensity Tolerance each Rank: +/-10%

Rank	I <sub>V</sub> (m	Condition	
	MIN.	MAX.	Condition
Α	10	16	
В	16	25	
C	25	40	I <sub>F</sub> =1mA
D	40	64	
E	64	-	

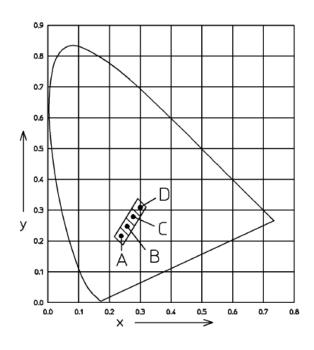
Please contact our sales staff concerning rank designation.

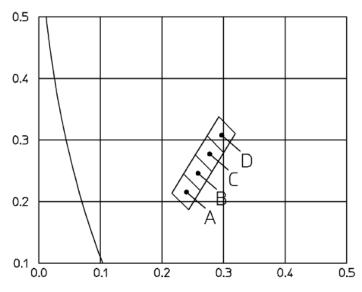




## Sorting Chart for Chromaticity Coordinates

(Ta=25℃)





Chromaticity Coordinates Tolerance Each Rank: +/-0.02

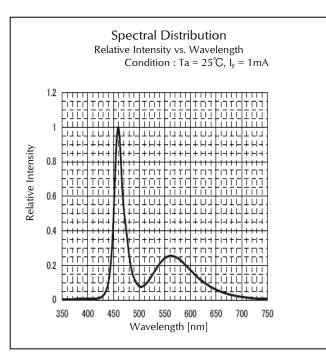
	LEFT DO	WN point	LEFT U	P point	RIGHT U	JP point	RIGHT U	JP point
Rank	x	у	x	у	x	у	x	у
Α	0.243	0.187	0.216	0.214	0.235	0.245	0.262	0.218
В	0.262	0.218	0.235	0.245	0.254	0.276	0.281	0.249
С	0.281	0.249	0.254	0.276	0.273	0.307	0.300	0.280
D	0.300	0.280	0.273	0.307	0.292	0.338	0.319	0.311

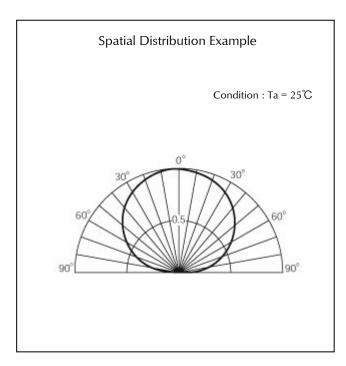
Please contact our sales staff concerning rank designation.

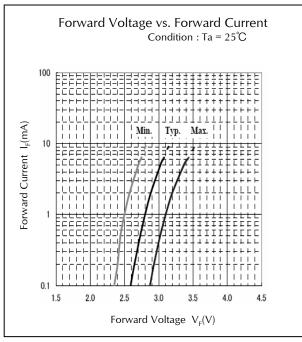


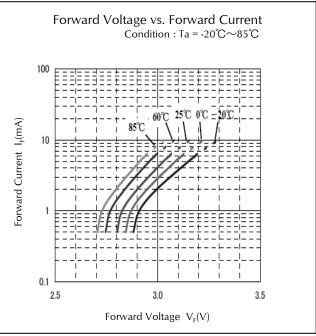


#### **Technical Data**





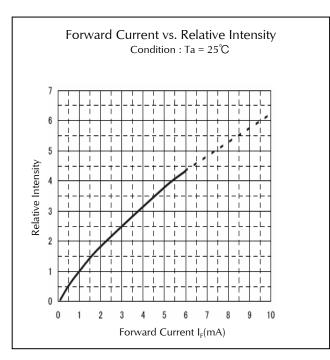


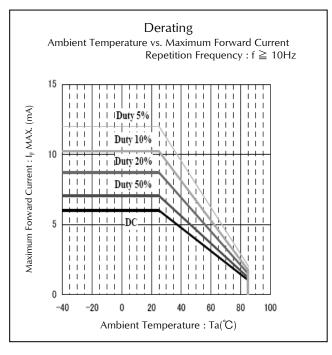


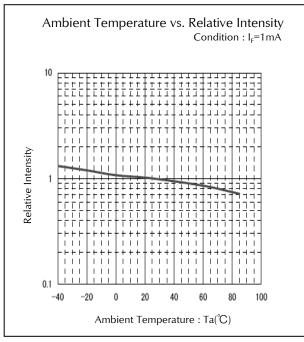


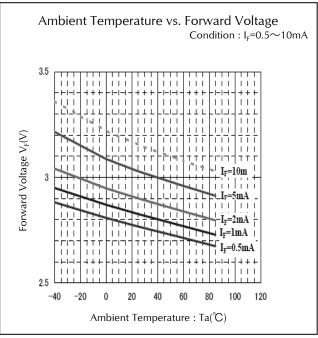


#### **Technical Data**

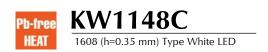




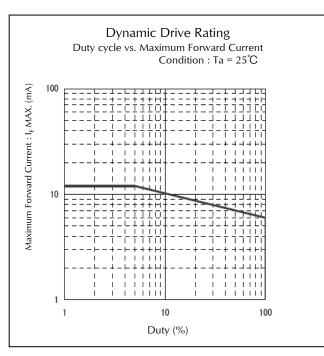


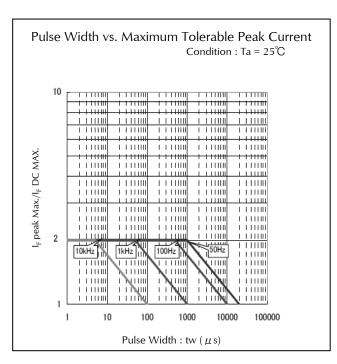


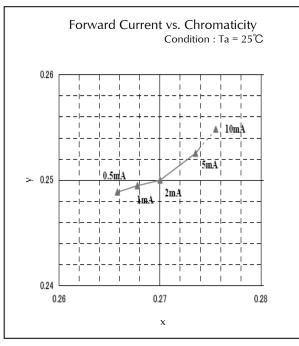


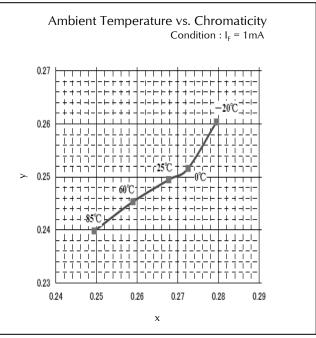


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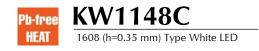








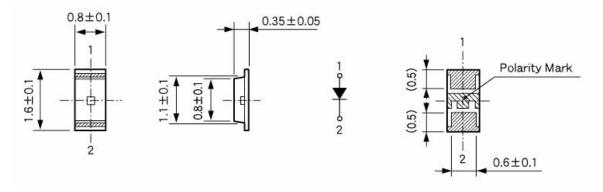




### Package Dimensions

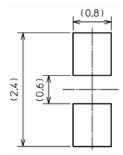
(Unit: mm)

Weight: (0.95)mg



#### Recommended Soldering Pattern

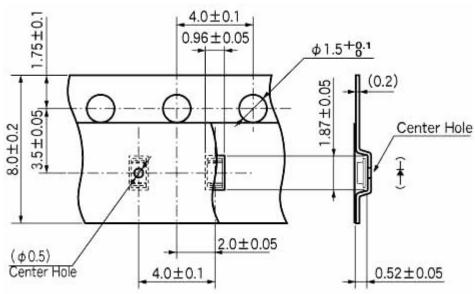
(Unit: mm)



## **Taping Specification**

(Unit: mm)

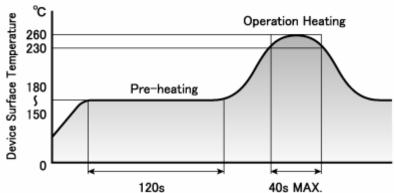
Quantity: 4,000pcs/ reel (standard)







#### **Reflow Soldering Conditions**



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6°C maximum)

#### **Manual Soldering Conditions**

Iron tip temp.	350 ℃	(MAX.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)





## Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	Pre-heating: 150∼180°C 120s Max. Operation Heating: 230°C 40s Max. Peak Temperature: 260°C	Twice	0/25
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min)  Normal Temperature(15min)  Maximum Rated Storage Temperature(30min)  Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$Ta = 60\pm2^{\circ}C$ , RH = $90\pm5\%$	1,000 h	0/25
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s <sup>2</sup> (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

## Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	lv	IF Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value ≧ Spec. Max. Value x 1.2
Reverse Current	<b> </b> R	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking





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